

AT17F080-30TQI Datasheet

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AT17F080-30TQI

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| | |
|------------------------------|--------------------------------------|
| DiGi Electronics Part Number | AT17F080-30TQI-DG |
| Manufacturer | Microchip Technology |
| Manufacturer Product Number | AT17F080-30TQI |
| Description | IC FLASH CONFIG 8M 44TQFP |
| Detailed Description | Memory, Integrated Circuits (ICs) |



Tel: +00 852-30501935

RFQ Email: Info@DiGi-Electronics.com

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Purchase and inquiry

Manufacturer Product Number:

AT17F080-30TQI

Series:

-

DiGi-Electronics Programmable:

Not Verified

Memory Size:

8Mb

Operating Temperature:

-40°C ~ 85°C

Package / Case:

44-TQFP

Base Product Number:

AT17F080

Manufacturer:

Microchip Technology

Product Status:

Obsolete

Programmable Type:

FLASH

Voltage - Supply:

2.97V ~ 3.63V

Mounting Type:

Surface Mount

Supplier Device Package:

44-TQFP (10x10)

Environmental & Export classification

RoHS Status:

RoHS non-compliant

REACH Status:

REACH Unaffected

HTSUS:

8542.32.0071

Moisture Sensitivity Level (MSL):

3 (168 Hours)

ECCN:

3A991B1A

Features

- Programmable 4,194,304 x 1 and 8,388,608 x 1-bit Serial Memories Designed to Store Configuration Programs for Field Programmable Gate Arrays (FPGAs)
- 3.3V Output Capability
- 5V Tolerant I/O Pins
- Program Support using the Atmel ATDH2200E System or Industry Third Party Programmers
- In-System Programmable (ISP) via 2-wire Bus
- Simple Interface to SRAM FPGAs
- Compatible with Atmel AT40K and AT94K Devices, Altera FLEX[®], APEX[™] Devices, Lucent ORCA[®] FPGAs, Xilinx XC3000[™], XC4000[™], XC5200[™], Spartan[®], Virtex[®] FPGAs, Motorola MPA1000 FPGAs
- Cascadable Read-back to Support Additional Configurations or Higher-density Arrays
- Low-power CMOS FLASH Process
- Available in 6 mm x 6 mm x 1 mm 8-lead LAP (Pin-compatible with 8-lead SOIC/VOIC Packages), 20-lead PLCC, 44-lead PLCC and 44-lead TQFP Packages
- Emulation of Atmel's AT24CXXX Serial EEPROMs
- Low-power Standby Mode
- Single Device Capable of Holding 4 Bit Stream Files Allowing Simple System Reconfiguration
- Fast Serial Download Speeds up to 33 MHz
- Endurance: 5,000 Write Cycles Typical

Description

The AT17F Series of In-System Programmable Configuration PROMs (Configurators) provide an easy-to-use, cost-effective configuration memory for Field Programmable Gate Arrays. The AT17F Series device is packaged in the 8-lead LAP, 20-lead PLCC, 44-lead PLCC and 44-lead TQFP, see Table 1. The AT17F Series Configurator uses a simple serial-access procedure to configure one or more FPGA devices.

The AT17F Series Configurators can be programmed with industry-standard programmers, Atmel's ATDH2200E Programming Kit or Atmel's ATDH2225 ISP Cable.

Table 1. AT17F Series Packages

| Package | AT17F040 | AT17F080 |
|--------------|----------|----------|
| 8-lead LAP | Yes | Yes |
| 20-lead PLCC | Yes | Yes |
| 44-lead PLCC | – | Yes |
| 44-lead TQFP | – | Yes |



FPGA Configuration Flash Memory

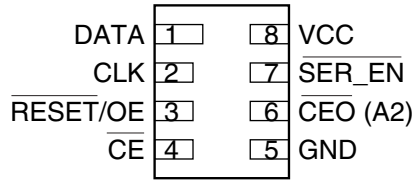
AT17F040
AT17F080



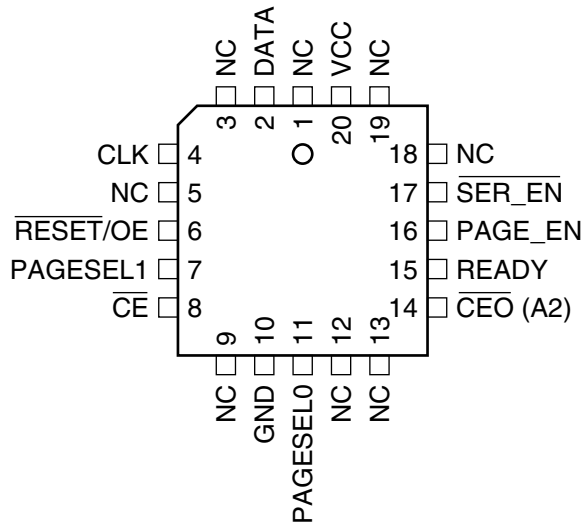


Pin Configuration

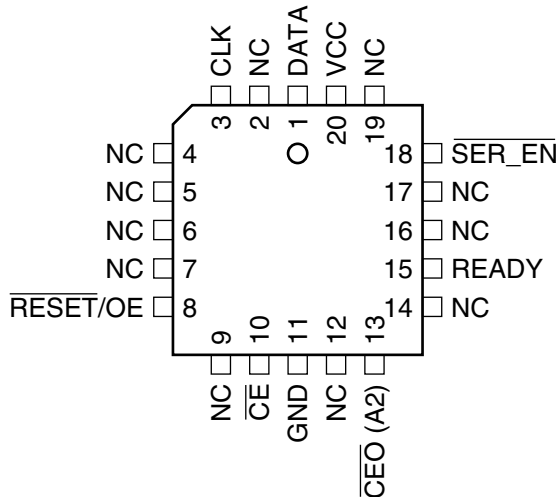
8-lead LAP



20-lead PLCC

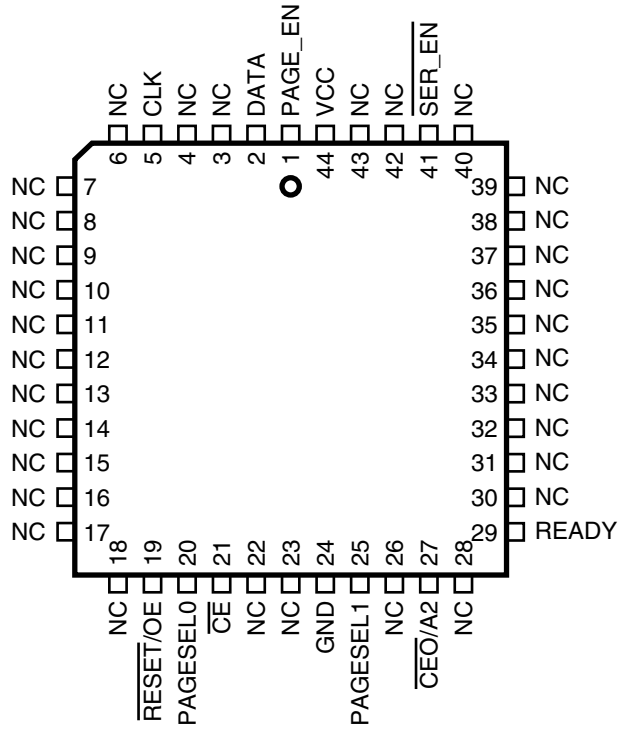


20-lead PLCC (Virtex® Pinout)⁽¹⁾⁽²⁾

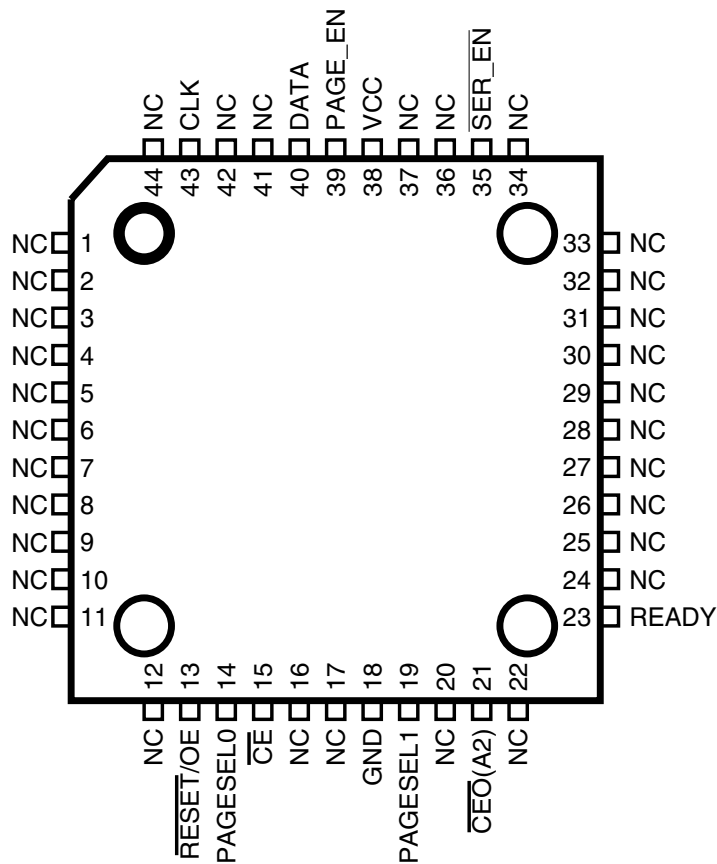


- Notes: 1. 20-lead PLCC (Virtex® pinout) is only available in the AT17F040.
 2. Virtex pinout is compatible with the XC17V and XC18V Series PROM.

44 PLCC

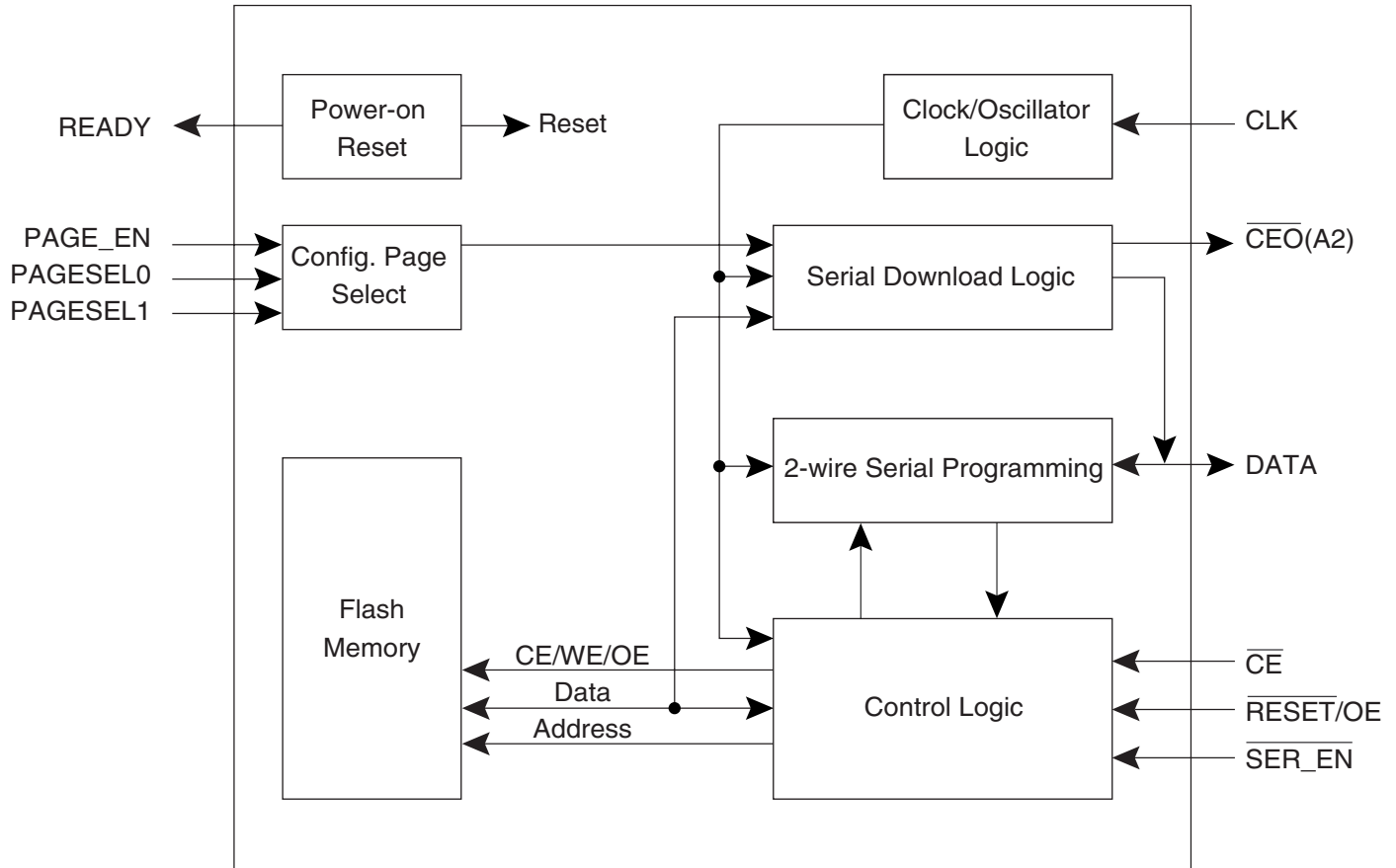


44 TQFP





Block Diagram



Device Description

The control signals for the configuration memory device (\overline{CE} , $\overline{RESET/OE}$ and CLK) interface directly with the FPGA device control signals. All FPGA devices can control the entire configuration process and retrieve data from the configuration device without requiring an external intelligent controller.

The $\overline{RESET/OE}$ and \overline{CE} pins control the tri-state buffer on the DATA output pin and enable the address counter. When $\overline{RESET/OE}$ is driven Low, the configuration device resets its address counter and tri-states its DATA pin. The \overline{CE} pin also controls the output of the AT17F Series Configurator. If \overline{CE} is held High after the $\overline{RESET/OE}$ reset pulse, the counter is disabled and the DATA output pin is tri-stated. When OE is subsequently driven High, the counter and the DATA output pin are enabled. When $\overline{RESET/OE}$ is driven Low again, the address counter is reset and the DATA output pin is tri-stated, regardless of the state of \overline{CE} .

When the configurator has driven out all of its data and $\overline{CE0}$ is driven Low, the device tri-states the DATA pin to avoid contention with other configurators. Upon power-up, the address counter is automatically reset.

Pin Description

| Name | I/O | AT17F040 | | | AT17F080 | | | |
|----------------------|-----|----------|---------|------------------|----------|---------|---------|---------|
| | | 8 LAP | 20 PLCC | 20 PLCC (Virtex) | 8 LAP | 20 PLCC | 44 PLCC | 44 TQFP |
| DATA | I/O | 1 | 2 | 1 | 1 | 2 | 2 | 40 |
| CLK | I | 2 | 4 | 3 | 2 | 4 | 5 | 43 |
| PAGE_EN | I | – | 16 | – | – | 16 | 1 | 39 |
| PAGESEL0 | I | – | 11 | – | – | 11 | 20 | 14 |
| PAGESEL1 | I | – | 7 | – | – | 7 | 25 | 19 |
| RESET/OE | I | 3 | 6 | 8 | 3 | 6 | 19 | 13 |
| \overline{CE} | I | 4 | 8 | 10 | 4 | 8 | 21 | 15 |
| GND | – | 5 | 10 | 11 | 5 | 10 | 24 | 18 |
| \overline{CEO} | O | 6 | 14 | 13 | 6 | 14 | 27 | 21 |
| A2 | I | | | | | | | |
| READY | O | – | 15 | 15 | – | 15 | 29 | 23 |
| $\overline{SER_EN}$ | I | 7 | 17 | 18 | 7 | 17 | 41 | 35 |
| V _{CC} | – | 8 | 20 | 20 | 8 | 20 | 44 | 38 |

DATA⁽¹⁾

Three-state DATA output for configuration. Open-collector bi-directional pin for programming.

CLK⁽¹⁾

Clock input. Used to increment the internal address and bit counter for reading and programming.

PAGE_EN⁽²⁾

Input used to enable page download mode. When PAGE_EN is high the configuration download address space is partitioned into 4 equal pages. This gives users the ability to easily store and retrieve multiple configuration bitstreams from a single configuration device. This input works in conjunction with the PAGESEL inputs. PAGE_EN must be remain low if paging is not desired. When SER_EN is Low (ISP mode) this pin has no effect.

- Notes:
1. This pin has an internal 20 K Ω pull-up resistor.
 2. This pin has an internal 30 K Ω pull-down resistor.

**PAGESEL[1:0]**⁽²⁾

Page select inputs. Used to determine which of the 4 memory pages are targeted during a serial configuration download. The address space for each of the pages is shown in Table 2. When $\overline{\text{SER_EN}}$ is Low (ISP mode) these pins have no effect.

Table 2. Address Space

| Paging Decodes | AT17F040 (4 Mbits) | AT17F080 (8 Mbits) |
|---------------------------|--------------------|--------------------|
| PAGESEL = 00, PAGE_EN = 1 | 00000 – 0FFFFh | 00000 – 1FFFFh |
| PAGESEL = 01, PAGE_EN = 1 | 10000 – 1FFFFh | 20000 – 3FFFFh |
| PAGESEL = 10, PAGE_EN = 1 | 20000 – 2FFFFh | 40000 – 5FFFFh |
| PAGESEL = 11, PAGE_EN = 1 | 30000 – 3FFFFh | 60000 – 7FFFFh |
| PAGESEL = XX, PAGE_EN = 0 | 00000 – 3FFFFh | 00000 – 7FFFFh |

 $\overline{\text{RESET/OE}}$ ⁽¹⁾

Output Enable (active High) and RESET (active Low) when $\overline{\text{SER_EN}}$ is High. A Low level on $\overline{\text{RESET/OE}}$ resets both the address and bit counters. A High level (with $\overline{\text{CE}}$ Low) enables the data output driver.

 $\overline{\text{CE}}$ ⁽¹⁾

Chip Enable input (active Low). A Low level (with OE High) allows CLK to increment the address counter and enables the data output driver. A High level on $\overline{\text{CE}}$ disables both the address and bit counters and forces the device into a low-power standby mode. Note that this pin will *not* enable/disable the device in the 2-wire Serial Programming mode ($\overline{\text{SER_EN}}$ Low).

GND

Ground pin. A 0.2 μF decoupling capacitor between V_{CC} and GND is recommended.

 $\overline{\text{CEO}}$

Chip Enable Output (when $\overline{\text{SER_EN}}$ is High). This output goes Low when the internal address counter has reached its maximum value. If the PAGE_EN input is set High, the maximum value is the highest address in the selected partition. The PAGESEL[1:0] inputs are used to make the 4 partition selections. If the PAGE_EN input is set Low, the device is not partitioned and the address maximum value is the highest address in the device, see Table 2 on page 6. In a daisy chain of AT17F Series devices, the $\overline{\text{CEO}}$ pin of one device must be connected to the $\overline{\text{CE}}$ input of the next device in the chain. It will stay Low as long as $\overline{\text{CE}}$ is Low and OE is High. It will then follow $\overline{\text{CE}}$ until OE goes Low; thereafter, $\overline{\text{CEO}}$ will stay High until the entire EEPROM is read again.

A2⁽¹⁾

Device selection input, (when $\overline{\text{SER_EN}}$ Low). The input is used to enable (or chip select) the device during programming (i.e., when $\overline{\text{SER_EN}}$ is Low). Refer to the AT17F Programming Specification available on the Atmel web site for additional details.

READY

Open collector reset state indicator. Driven Low during power-up reset, released when power-up is complete. (recommended 4.7 k Ω pull-up on this pin if used).

 $\overline{\text{SER_EN}}$ ⁽¹⁾

The serial enable input must remain High during FPGA configuration operations. Bringing $\overline{\text{SER_EN}}$ Low enables the 2-Wire Serial Programming Mode. For non-ISP applications, $\overline{\text{SER_EN}}$ should be tied to V_{CC} .

 V_{CC}

+3.3V ($\pm 10\%$).

- Notes:
1. This pin has an internal 20 k Ω pull-up resistor.
 2. This pin has an internal 30 k Ω pull-down resistor.

FPGA Master Serial Mode Summary

The I/O and logic functions of any SRAM-based FPGA are established by a configuration program. The program is loaded either automatically upon power-up, or on command, depending on the state of the FPGA mode pins. In Master mode, the FPGA automatically loads the configuration program from an external memory. The AT17F Serial Configuration PROM has been designed for compatibility with the Master Serial mode.

This document discusses the Atmel AT40K, AT40KAL and AT94KAL applications as well as Xilinx applications.

Control of Configuration

Most connections between the FPGA device and the AT17F Serial Configurator PROM are simple and self-explanatory.

- The DATA output of the AT17F Series Configurator drives DIN of the FPGA devices.
- The master FPGA CCLK output drives the CLK input of the AT17F Series Configurator.
- The $\overline{\text{CEO}}$ output of any AT17F Series Configurator drives the $\overline{\text{CE}}$ input of the next Configurator in a cascade chain of configurator devices.
- $\overline{\text{SER_EN}}$ must be connected to V_{CC} (except during ISP).
- The READY pin is available as an open-collector indicator of the device's reset status; it is driven Low while the device is in its power-on reset cycle and released (tri-stated) when the cycle is complete.
- PAGE_EN must be held Low if download paging is not desired. The PAGESEL[1:0] inputs must be tied off High or Low. If paging is desired, PAGE_EN must be High and the PAGESEL pins must be set to High or Low such that the desired page is selected, see Table 2 on page 6.

Cascading Serial Configuration Devices

For multiple FPGAs configured as a daisy-chain, or for FPGAs requiring larger configuration memories, cascaded configurators provide additional memory.

After the last bit from the first configurator is read, the clock signal to the configurator asserts its $\overline{\text{CEO}}$ output Low and disables its DATA line driver. The second configurator recognizes the Low level on its $\overline{\text{CE}}$ input and enables its DATA output.

After configuration is complete, the address counters of all cascaded configurators are reset if the $\overline{\text{RESET/OE}}$ on each configurator is driven to its active (Low) level.

If the address counters are not to be reset upon completion, then the $\overline{\text{RESET/OE}}$ input can be tied to its inactive (High) level.

Programming Mode

The programming mode is entered by bringing $\overline{\text{SER_EN}}$ Low. In this mode the chip can be programmed by the 2-wire serial bus. The programming is done at V_{CC} supply only. Programming super voltages are generated inside the chip. The AT17F parts are read/write at 3.3V nominal. Refer to the AT17F Programming Specification available on the Atmel web site (www.atmel.com) for more programming details. AT17F devices are supported by the Atmel ATDH2200 programming system along with many third party programmers.

Standby Mode

The AT17F Series Configurators enter a low-power standby mode whenever $\overline{\text{SER_EN}}$ is High and $\overline{\text{CE}}$ is asserted High. In this mode, the AT17F Configurator consumes less than 1 mA of current at 3.3V. The output remains in a high-impedance state regardless of the state of the OE input.



Absolute Maximum Ratings*

| | |
|--|--------------------------|
| Operating Temperature..... | -40°C to +85°C |
| Storage Temperature..... | -65°C to +150°C |
| Voltage on Any Pin with Respect to Ground | -0.1V to $V_{CC} + 0.5V$ |
| Supply Voltage (V_{CC}) | -0.5V to +4.0V |
| Maximum Soldering Temp. (10 sec. @ 1/16 in.)..... | 260°C |
| ESD ($R_{ZAP} = 1.5K$, $C_{ZAP} = 100$ pF)..... | 2000V |

*NOTICE: Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions beyond those listed under operating conditions is not implied. Exposure to Absolute Maximum Rating conditions for extended periods of time may affect device reliability.

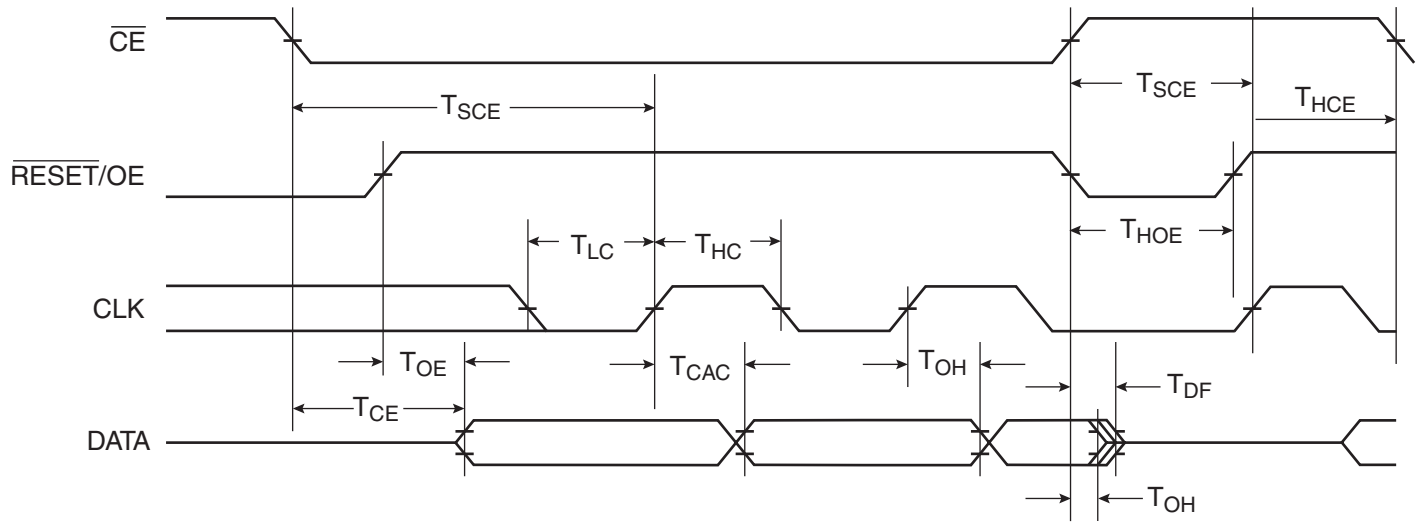
Operating Conditions

| Symbol | Description | AT17F Series Configurator | | Units | |
|----------|-------------|--|------|-------|---|
| | | Min | Max | | |
| V_{CC} | Commercial | Supply voltage relative to GND -0°C to +70°C | 2.97 | 3.63 | V |
| | Industrial | Supply voltage relative to GND -40°C to +85°C | 2.97 | 3.63 | V |

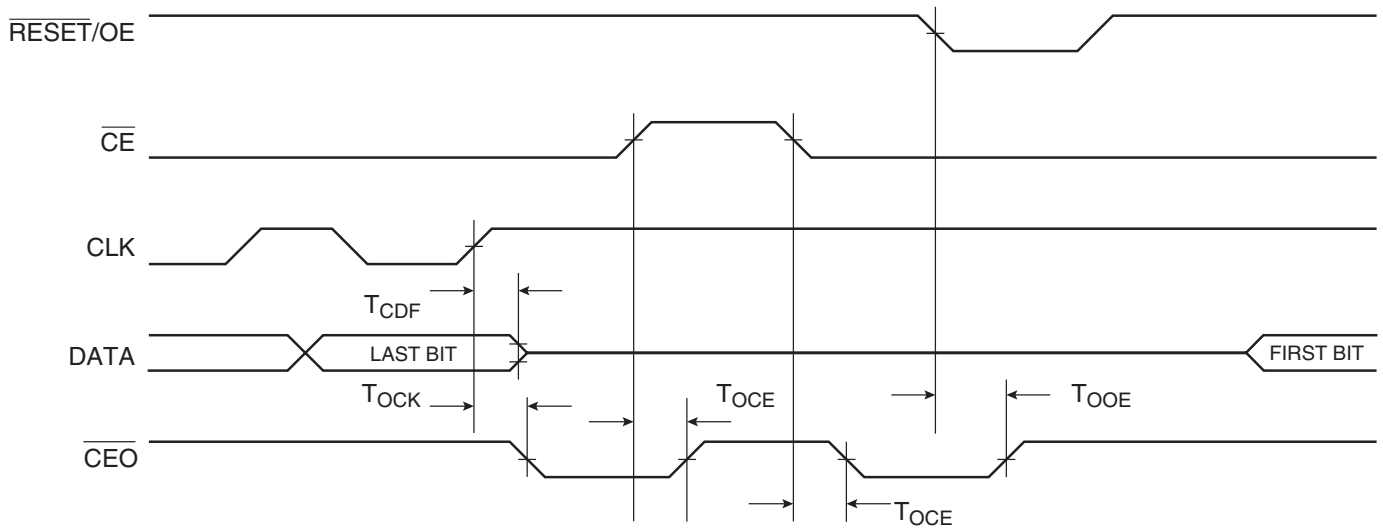
DC Characteristics

| Symbol | Description | AT17F040 | | AT17F080 | | Units |
|-----------|---|------------|----------|----------|----------|---------|
| | | Min | Max | Min | Max | |
| V_{IH} | High-level Input Voltage | 2.0 | V_{CC} | 2.0 | V_{CC} | V |
| V_{IL} | Low-level Input Voltage | 0 | 0.8 | 0 | 0.8 | V |
| V_{OH} | High-level Output Voltage ($I_{OH} = -2.5$ mA) | 2.4 | 0.4 | 2.4 | 0.4 | V |
| V_{OL} | Low-level Output Voltage ($I_{OL} = +3$ mA) | | | | | |
| V_{OH} | High-level Output Voltage ($I_{OH} = -2$ mA) | 2.4 | 0.4 | 2.4 | 0.4 | V |
| V_{OL} | Low-level Output Voltage ($I_{OL} = +3$ mA) | | | | | |
| I_{CCA} | Supply Current, Active Mode | | 20 | | 20 | mA |
| I_L | Input or Output Leakage Current ($V_{IN} = V_{CC}$ or GND) | -10 | 10 | -10 | 10 | μA |
| I_{CCS} | Supply Current, Standby Mode | Commercial | 1 | | 1 | mA |
| | | Industrial | 1 | | 1 | mA |

AC Characteristics



AC Characteristics when Cascading





AC Characteristics

| Symbol | Description | | AT17F040 | | AT17F080 | | Units |
|---------------------------------|---|---------------------------|----------|-----|----------|-----|-------|
| | | | Min | Max | Min | Max | |
| T _{OE} ⁽²⁾ | OE to Data Delay | Commercial | | 50 | | 50 | ns |
| | | Industrial ⁽¹⁾ | | 55 | | 55 | ns |
| T _{CE} ⁽²⁾ | $\overline{\text{CE}}$ to Data Delay | Commercial | | 60 | | 55 | ns |
| | | Industrial ⁽¹⁾ | | 60 | | 60 | ns |
| T _{CAC} ⁽²⁾ | CLK to Data Delay | Commercial | | 30 | 3 | 30 | ns |
| | | Industrial ⁽¹⁾ | | 30 | | 30 | ns |
| T _{OH} | Data Hold from $\overline{\text{CE}}$, OE, or CLK | Commercial | 0 | | 0 | | ns |
| | | Industrial ⁽¹⁾ | 0 | | 0 | | ns |
| T _{DF} ⁽³⁾ | $\overline{\text{CE}}$ or OE to Data Float Delay | Commercial | | 15 | | 15 | ns |
| | | Industrial ⁽¹⁾ | | 15 | | 15 | ns |
| T _{LC} | CLK Low Time | Commercial | 15 | | 15 | | ns |
| | | Industrial ⁽¹⁾ | 15 | | 15 | | ns |
| T _{HC} | CLK High Time | Commercial | 15 | | 15 | | ns |
| | | Industrial ⁽¹⁾ | 15 | | 15 | | ns |
| T _{SCE} | $\overline{\text{CE}}$ Setup Time to CLK (to guarantee proper counting) | Commercial | 35 | | 20 | | ns |
| | | Industrial ⁽¹⁾ | 40 | | 25 | | ns |
| T _{HCE} | $\overline{\text{CE}}$ Hold Time from CLK (to guarantee proper counting) | Commercial | 0 | | 0 | | ns |
| | | Industrial ⁽¹⁾ | 0 | | 0 | | ns |
| T _{HOE} | Reset/OE Low Time (guarantees counter is reset) | Commercial | 20 | | 20 | | ns |
| | | Industrial ⁽¹⁾ | 20 | | 20 | | ns |
| F _{MAX} | Maximum Input Clock Frequency SEREN = 0 | Commercial | | 10 | | 10 | MHz |
| | | Industrial ⁽¹⁾ | | 10 | | 10 | MHz |
| F _{MAX} | Maximum Input Clock Frequency SEREN = 1 | Commercial | | 33 | | 33 | MHz |
| | | Industrial ⁽¹⁾ | | 33 | | 33 | MHz |
| T _{WR} | Write Cycle Time ⁽⁴⁾ | Commercial | | 30 | | 30 | μs |
| | | Industrial ⁽¹⁾ | | 30 | | 30 | μs |
| T _{EC} | Erase Cycle Time ⁽⁴⁾ | Commercial | | 30 | | 10 | μs |
| | | Industrial ⁽¹⁾ | | 30 | | 10 | μs |

- Notes:
1. Preliminary specifications for military operating range only.
 2. AC test lead = 50 pF.
 3. Float delays are measured with 5 pF AC loads. Transition is measured ± 200 mV from steady-state active levels.
 4. See the AT17F Programming Specification for procedural information.

AC Characteristics When Cascading

| Symbol | Description | | AT17F040 | | AT17F080 | | Units |
|---------------------------------|---|------------|----------|-----|----------|-----|-------|
| | | | Min | Max | Min | Max | |
| T _{CDF} ⁽³⁾ | CLK to Data Float Delay | Commercial | | 60 | | 50 | ns |
| | | Industrial | | 60 | | 50 | ns |
| T _{OCK} ⁽²⁾ | CLK to $\overline{\text{CEO}}$ Delay | Commercial | | 55 | | 50 | ns |
| | | Industrial | | 60 | | 55 | ns |
| T _{OCE} ⁽²⁾ | $\overline{\text{CE}}$ to $\overline{\text{CEO}}$ Delay | Commercial | | 55 | | 35 | ns |
| | | Industrial | | 60 | | 40 | ns |
| T _{OOE} ⁽²⁾ | $\overline{\text{RESET/OE}}$ to $\overline{\text{CEO}}$ Delay | Commercial | | 40 | | 35 | ns |
| | | Industrial | | 45 | | 35 | ns |
| F _{MAX} | Maximum Input Clock Frequency | Commercial | | 33 | | 33 | MHz |
| | | Industrial | | 33 | | 33 | MHz |

- Notes: 1. AC test lead = 50 pF.
 2. Float delays are measured with 5 pF AC loads. Transition is measured ± 200 mV from steady-state active levels.



Thermal Resistance Coefficients

| Package Type | | | AT17F040 | AT17F080 |
|--------------|---------------------------------------|--|----------|----------|
| 8CN4 | Leadless Array Package (LAP) | θ_{JC} [$^{\circ}\text{C}/\text{W}$] | | – |
| | | θ_{JA} [$^{\circ}\text{C}/\text{W}$] ⁽¹⁾ | | – |
| 20J | Plastic Leaded Chip Carrier (PLCC) | θ_{JC} [$^{\circ}\text{C}/\text{W}$] | | – |
| | | θ_{JA} [$^{\circ}\text{C}/\text{W}$] ⁽¹⁾ | | – |
| 44A | Thin Plastic Quad Flat Package (TQFP) | θ_{JC} [$^{\circ}\text{C}/\text{W}$] | – | 17 |
| | | θ_{JA} [$^{\circ}\text{C}/\text{W}$] ⁽¹⁾ | – | 62 |
| 44J | Plastic Leaded Chip Carrier (PLCC) | θ_{JC} [$^{\circ}\text{C}/\text{W}$] | – | 15 |
| | | θ_{JA} [$^{\circ}\text{C}/\text{W}$] ⁽¹⁾ | – | 50 |

Note: 1. Airflow = 0 ft/min.

Ordering Information

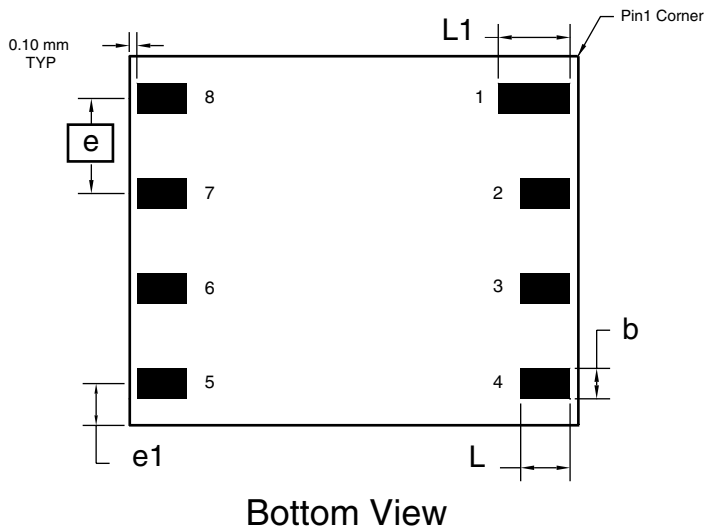
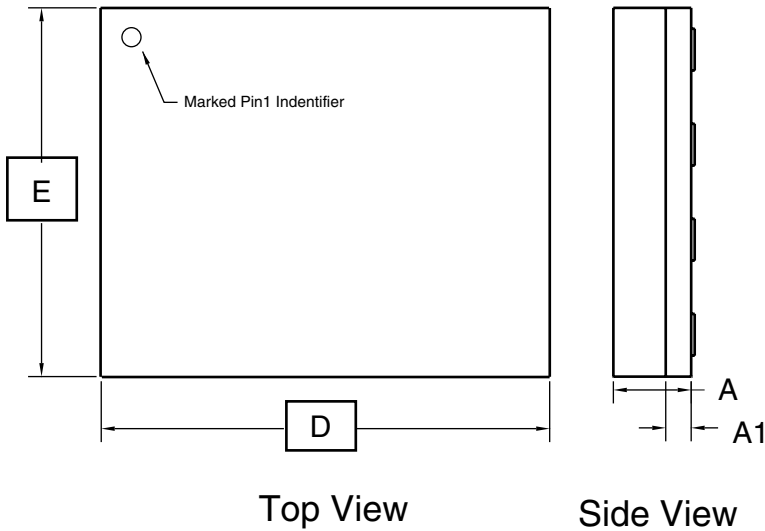
| Memory Size | Ordering Code | Package | Operation Range |
|----------------|----------------|---------------|-------------------------------|
| 4-Mbit | AT17F040-30CC | 8CN4 - 8 LAP | Commercial (0°C to 70°C) |
| | AT17F040-30JC | 20J - 20 PLCC | |
| | AT17F040-30VJC | 20J - 20 PLCC | |
| | AT17F040-30CI | 8CN4 - 8 LAP | Industrial (-40°C to 85°C) |
| | AT17F040-30JI | 20J - 20 PLCC | |
| | AT17F040-30VJI | 20J - 20 PLCC | |
| 8-Mbit | AT17F080-30CC | 8CN4 - 8 LAP | Commercial (0°C to 70°C) |
| | AT17F080-30JC | 20J - 20 PLCC | |
| | AT17F080-30TQC | 44A - 44 TQFP | |
| | AT17F080-30BJC | 44J - 44 PLCC | |
| | AT17F080-30CI | 8CN4 - 8 LAP | Industrial (-40°C to 85°C) |
| | AT17F080-30JI | 20J - 20 PLCC | |
| AT17F080-30TQI | 44A - 44 TQFP | | |
| | AT17F080-30BJI | 44J - 44 PLCC | |

| Package Type | |
|--------------|--|
| 8CN4 | 8-lead, 6 mm x 6 mm x 1 mm, Leadless Array Package (LAP) – Pin-compatible with 8-lead SOIC/VOID Packages |
| 20J | 20-lead, Plastic J-leaded Chip Carrier (PLCC) |
| 44A | 44-lead, Thin (1.0 mm) Plastic Quad Flat Package Carrier (TQFP) |
| 44J | 44-lead, Plastic J-leaded Chip Carrier (PLCC) |



Packaging Information

8CN4 – LAP



COMMON DIMENSIONS
(Unit of Measure = mm)

| SYMBOL | MIN | NOM | MAX | NOTE |
|--------|----------|------|------|------|
| A | 0.94 | 1.04 | 1.14 | |
| A1 | 0.30 | 0.34 | 0.38 | |
| b | 0.45 | 0.50 | 0.55 | 1 |
| D | 5.89 | 5.99 | 6.09 | |
| E | 4.89 | 5.99 | 6.09 | |
| e | 1.27 BSC | | | |
| e1 | 1.10 REF | | | |
| L | 0.95 | 1.00 | 1.05 | 1 |
| L1 | 1.25 | 1.30 | 1.35 | 1 |

Note: 1. Metal Pad Dimensions.

11/14/01



2325 Orchard Parkway
San Jose, CA 95131

TITLE

8CN4, 8-lead (6 x 6 x 1.04 mm Body), Lead Pitch 1.27 mm,
Leadless Array Package (LAP)

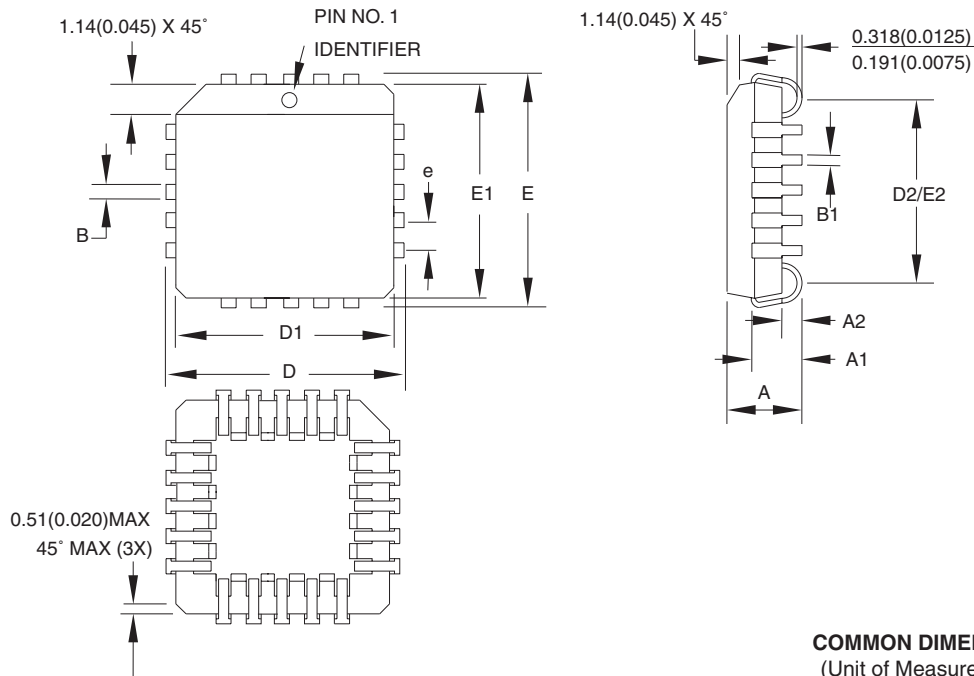
DRAWING NO.

8CN4

REV.

A

20J – PLCC



COMMON DIMENSIONS
(Unit of Measure = mm)

| SYMBOL | MIN | NOM | MAX | NOTE |
|--------|-----------|-----|--------|--------|
| A | 4.191 | – | 4.572 | |
| A1 | 2.286 | – | 3.048 | |
| A2 | 0.508 | – | – | |
| D | 9.779 | – | 10.033 | |
| D1 | 8.890 | – | 9.042 | Note 2 |
| E | 9.779 | – | 10.033 | |
| E1 | 8.890 | – | 9.042 | Note 2 |
| D2/E2 | 7.366 | – | 8.382 | |
| B | 0.660 | – | 0.813 | |
| B1 | 0.330 | – | 0.533 | |
| e | 1.270 TYP | | | |

- Notes:
1. This package conforms to JEDEC reference MS-018, Variation AA.
 2. Dimensions D1 and E1 do not include mold protrusion. Allowable protrusion is .010" (0.254 mm) per side. Dimension D1 and E1 include mold mismatch and are measured at the extreme material condition at the upper or lower parting line.
 3. Lead coplanarity is 0.004" (0.102 mm) maximum.

10/04/01



2325 Orchard Parkway
San Jose, CA 95131

TITLE

20J, 20-lead, Plastic J-leaded Chip Carrier (PLCC)

DRAWING NO.

20J

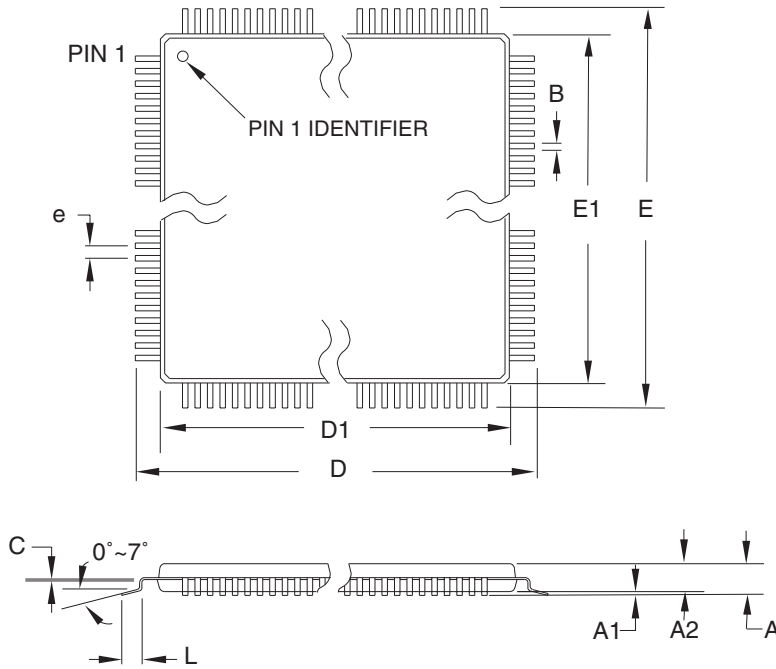
REV.

B





44A – TQFP



COMMON DIMENSIONS
(Unit of Measure = mm)

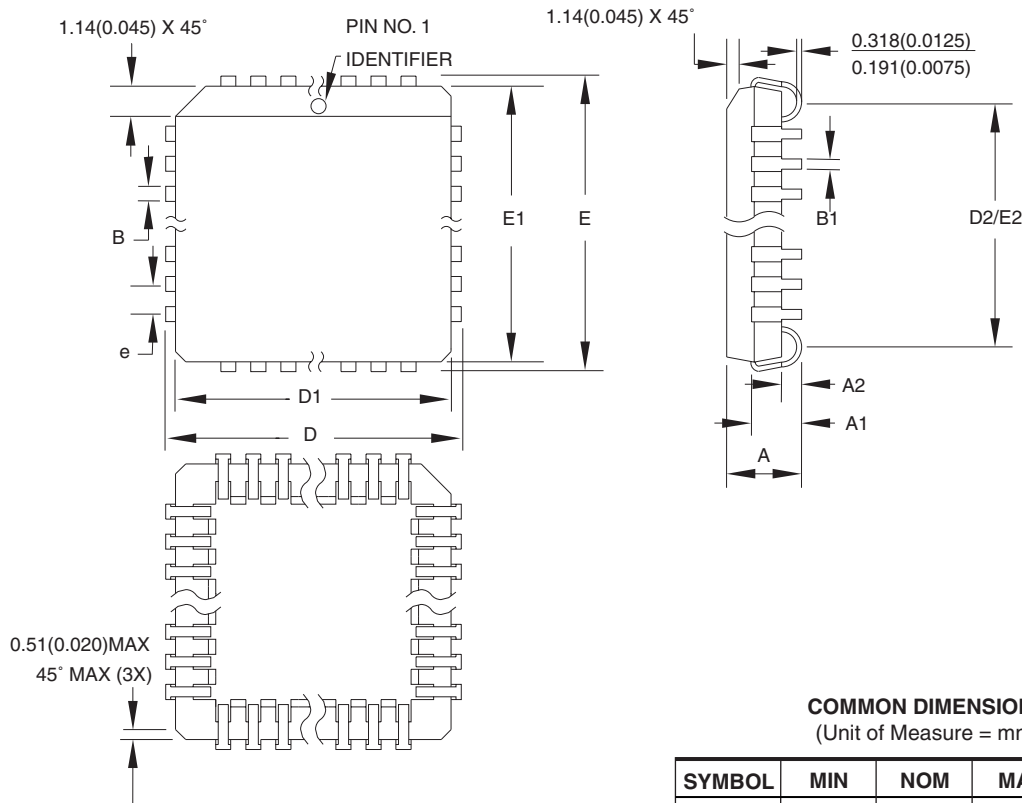
| SYMBOL | MIN | NOM | MAX | NOTE |
|--------|----------|-------|-------|--------|
| A | – | – | 1.20 | |
| A1 | 0.05 | – | 0.15 | |
| A2 | 0.95 | 1.00 | 1.05 | |
| D | 11.75 | 12.00 | 12.25 | |
| D1 | 9.90 | 10.00 | 10.10 | Note 2 |
| E | 11.75 | 12.00 | 12.25 | |
| E1 | 9.90 | 10.00 | 10.10 | Note 2 |
| B | 0.30 | – | 0.45 | |
| C | 0.09 | – | 0.20 | |
| L | 0.45 | – | 0.75 | |
| e | 0.80 TYP | | | |

- Notes:
1. This package conforms to JEDEC reference MS-026, Variation ACB.
 2. Dimensions D1 and E1 do not include mold protrusion. Allowable protrusion is 0.25 mm per side. Dimensions D1 and E1 are maximum plastic body size dimensions including mold mismatch.
 3. Lead coplanarity is 0.10 mm maximum.

10/5/2001

| | | | |
|--|--|--------------------|-------------|
| 2325 Orchard Parkway San Jose, CA 95131 | TITLE | DRAWING NO. | REV. |
| | 44A , 44-lead, 10 x 10 mm Body Size, 1.0 mm Body Thickness, 0.8 mm Lead Pitch, Thin Profile Plastic Quad Flat Package (TQFP) | 44A | B |

44J – PLCC



COMMON DIMENSIONS
(Unit of Measure = mm)

| SYMBOL | MIN | NOM | MAX | NOTE |
|--------|-----------|-----|--------|--------|
| A | 4.191 | – | 4.572 | |
| A1 | 2.286 | – | 3.048 | |
| A2 | 0.508 | – | – | |
| D | 17.399 | – | 17.653 | |
| D1 | 16.510 | – | 16.662 | Note 2 |
| E | 17.399 | – | 17.653 | |
| E1 | 16.510 | – | 16.662 | Note 2 |
| D2/E2 | 14.986 | – | 16.002 | |
| B | 0.660 | – | 0.813 | |
| B1 | 0.330 | – | 0.533 | |
| e | 1.270 TYP | | | |

- Notes:
1. This package conforms to JEDEC reference MS-018, Variation AC.
 2. Dimensions D1 and E1 do not include mold protrusion. Allowable protrusion is .010" (0.254 mm) per side. Dimension D1 and E1 include mold mismatch and are measured at the extreme material condition at the upper or lower parting line.
 3. Lead coplanarity is 0.004" (0.102 mm) maximum.

10/04/01



2325 Orchard Parkway
San Jose, CA 95131

TITLE

44J, 44-lead, Plastic J-leaded Chip Carrier (PLCC)

DRAWING NO.

44J

REV.

B





Atmel Corporation

2325 Orchard Parkway
San Jose, CA 95131, USA
Tel: 1(408) 441-0311
Fax: 1(408) 487-2600

Regional Headquarters

Europe

Atmel Sarl
Route des Arsenalux 41
Case Postale 80
CH-1705 Fribourg
Switzerland
Tel: (41) 26-426-5555
Fax: (41) 26-426-5500

Asia

Room 1219
Chinachem Golden Plaza
77 Mody Road Tsimshatsui
East Kowloon
Hong Kong
Tel: (852) 2721-9778
Fax: (852) 2722-1369

Japan

9F, Tonetsu Shinkawa Bldg.
1-24-8 Shinkawa
Chuo-ku, Tokyo 104-0033
Japan
Tel: (81) 3-3523-3551
Fax: (81) 3-3523-7581

Atmel Operations

Memory

2325 Orchard Parkway
San Jose, CA 95131, USA
Tel: 1(408) 441-0311
Fax: 1(408) 436-4314

Microcontrollers

2325 Orchard Parkway
San Jose, CA 95131, USA
Tel: 1(408) 441-0311
Fax: 1(408) 436-4314

La Chantrerie
BP 70602
44306 Nantes Cedex 3, France
Tel: (33) 2-40-18-18-18
Fax: (33) 2-40-18-19-60

ASIC/ASSP/Smart Cards

Zone Industrielle
13106 Rousset Cedex, France
Tel: (33) 4-42-53-60-00
Fax: (33) 4-42-53-60-01

1150 East Cheyenne Mtn. Blvd.
Colorado Springs, CO 80906, USA
Tel: 1(719) 576-3300
Fax: 1(719) 540-1759

Scottish Enterprise Technology Park
Maxwell Building
East Kilbride G75 0QR, Scotland
Tel: (44) 1355-803-000
Fax: (44) 1355-242-743

RF/Automotive

Theresienstrasse 2
Postfach 3535
74025 Heilbronn, Germany
Tel: (49) 71-31-67-0
Fax: (49) 71-31-67-2340

1150 East Cheyenne Mtn. Blvd.
Colorado Springs, CO 80906, USA
Tel: 1(719) 576-3300
Fax: 1(719) 540-1759

Biometrics/Imaging/Hi-Rel MPU/ High Speed Converters/RF Datacom

Avenue de Rochepleine
BP 123
38521 Saint-Egreve Cedex, France
Tel: (33) 4-76-58-30-00
Fax: (33) 4-76-58-34-80

Literature Requests

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